CP-5000D

~Copper paste for electronic parts electrode~

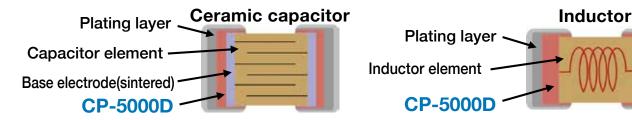
Resin cure type copper paste applocable for electrode of electronic parts.

Features

- Replacing silver to copper reduces cost.
- Possesses the same performance as silver paste.
- Containing resin in copper paste ease the stress on components after mounted on the substrate.

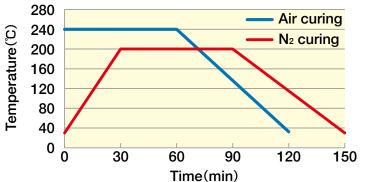
Applicable position of copper paste for electronic component

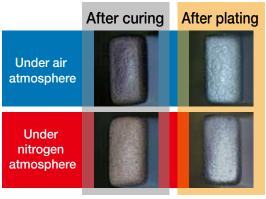
Our copper paste is applicable for electronic component.



Curing profile

 Our copper paste is curable under both air and nitrogen atmosphere, and able to form plating layer on the cured copper paste.





Electric resistance value change of the cured copper paste

Our copper paste maintains high reliability.

High-temperature/High-humidity Test(85°C/85%RH)

